

REVISIONS																			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED																
A	Add vendor CAGE 01295 to case outlines R and 2. Add vendor CAGE 27014 to case outline 2.	1987 SEPT 23	<i>M.A. Lye</i>																
B	Change vendor CAGE code to 67268. Add case outline S to drawing. Add vendor CAGE 01295 to case outline S. Remove vendor CAGE 04713 from drawing. Editorial changes to table I. Editorial changes throughout.	1989 JUL 24	<i>M.A. Lye</i>																

CURRENT CAGE CODE 67268

REV																			
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SHEET																			
REV STATUS OF SHEETS	REV	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B		
	SHEET	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		

<p>PMIC N/A</p> <p style="text-align: center; font-weight: bold; font-size: 1.1em;">STANDARDIZED MILITARY DRAWING</p> <p style="font-size: 0.8em;">THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE</p> <p>AMSC N/A</p>	<p>PREPARED BY <i>James E. Nicklaus</i></p> <p>CHECKED BY <i>Ray Monnin</i></p> <p>APPROVED BY <i>[Signature]</i></p> <p>DRAWING APPROVAL DATE 17 JULY 1986</p> <p>REVISION LEVEL B</p>	<p style="text-align: center; font-weight: bold;">DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444</p> <p style="font-size: 0.8em;">MICROCIRCUITS, DIGITAL, HIGH SPEED, CMOS, OCTAL, D-TYPE LATCH, MONOLITHIC SILICON</p> <table style="width: 100%; border: none;"> <tr> <td style="border: 1px solid black; width: 15%; text-align: center; font-weight: bold;">SIZE A</td> <td style="border: 1px solid black; width: 35%; text-align: center; font-weight: bold;">CAGE CODE 14933</td> <td style="border: 1px solid black; width: 50%; text-align: center; font-weight: bold;">5962-86062</td> </tr> <tr> <td colspan="2" style="border: none;">SHEET</td> <td style="border: none;">OF 1</td> </tr> </table>	SIZE A	CAGE CODE 14933	5962-86062	SHEET		OF 1
SIZE A	CAGE CODE 14933	5962-86062						
SHEET		OF 1						

DESC FORM 193-1  
SEP 87

U.S. GOVERNMENT PRINTING OFFICE: 1987 — 748-129/60912  
5962-E1253

DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

## 1. SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:

5962-86062	01	R	X
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Drawing number	Device type (1.2.1)	Case outline (1.2.2)	Lead finish per MIL-M-38510

1.2.1 Device type. The device type shall identify the circuit function as follows:

Device type	Generic number	Circuit function
01	54HC563	Octal, 3-state, inverting D-type, transparent latch

1.2.2 Case outlines. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter	Case outline
R	D-8 (20-lead, 1.060" x .310" x .200"), dual-in-line package
S	F-9 (20 lead, .540" x .300" x .100") flat package
2	C-2 (20-terminal .358" x .358" x .100"), square chip carrier package

1.3 Absolute maximum ratings. 1/

Supply voltage range - - - - -	-0.5 V dc to +7 V dc
DC input voltage - - - - -	-0.5 V dc to $V_{CC} + 0.5$ V dc
DC output voltage - - - - -	-0.5 V dc to $V_{CC} + 0.5$ V dc
Clamp diode current ( $I_{IK}, I_{OK}$ ) - - - - -	$\pm 20$ mA
DC output current (per pin) - - - - -	$\pm 35$ mA
DC $V_{CC}$ or GND current (per pin) - - - - -	$\pm 70$ mA
Storage temperature range - - - - -	-65°C to +150°C
Maximum power dissipation ( $P_D$ ) 2/ - - - - -	500 mW
Lead temperature (soldering, 10 seconds) - - - - -	+260°C
Thermal resistance, junction-to-case ( $\theta_{JC}$ ): Cases R, S, and 2 - - - - -	See MIL-M-38510, appendix C
Junction temperature ( $T_J$ ) - - - - -	+175°C

1/ Unless otherwise specified, all voltages are referenced to ground.

2/ For  $T_C = +100^\circ\text{C}$  to  $+125^\circ\text{C}$ , derate linearly at 12 mW/°C.

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>	5962-86062	
	REVISION LEVEL B		SHEET 2

DESC FORM 193A  
SEP 87

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#### 1.4 Recommended operating conditions.

Supply voltage range - - - - - +2.0 V dc to +6.0 V dc  
Case operating temperature range ( $T_C$ ) - - - - - -55°C to +125°C  
Input rise or fall time:

$V_{CC} = 2.0$  V - - - - - 0 to 1,000 ns  
 $V_{CC} = 4.5$  V - - - - - 0 to 500 ns  
 $V_{CC} = 6.0$  V - - - - - 0 to 400 ns

Minimum setup time ( $t_s$ ):

$T_C = +25^\circ\text{C}$ :  
 $V_{CC} = 2.0$  V - - - - - 75 ns  
 $V_{CC} = 4.5$  V - - - - - 15 ns  
 $V_{CC} = 6.0$  V - - - - - 13 ns

$T_C = -55^\circ\text{C to } +125^\circ\text{C}$ :  
 $V_{CC} = 2.0$  V - - - - - 110 ns  
 $V_{CC} = 4.5$  V - - - - - 22 ns  
 $V_{CC} = 6.0$  V - - - - - 19 ns

Minimum hold time ( $t_h$ ):

$T_C = +25^\circ\text{C}$ :  
 $V_{CC} = 2.0$  V - - - - - 50 ns  
 $V_{CC} = 4.5$  V - - - - - 10 ns  
 $V_{CC} = 6.0$  V - - - - - 9 ns

$T_C = -55^\circ\text{C to } +125^\circ\text{C}$ :  
 $V_{CC} = 2.0$  V - - - - - 75 ns  
 $V_{CC} = 4.5$  V - - - - - 15 ns  
 $V_{CC} = 6.0$  V - - - - - 13 ns

Minimum pulse width ( $t_w$ ):

$T_C = +25^\circ\text{C}$ :  
 $V_{CC} = 2.0$  V - - - - - 80 ns  
 $V_{CC} = 4.5$  V - - - - - 16 ns  
 $V_{CC} = 6.0$  V - - - - - 14 ns

$T_C = -55^\circ\text{C to } +125^\circ\text{C}$ :  
 $V_{CC} = 2.0$  V - - - - - 120 ns  
 $V_{CC} = 4.5$  V - - - - - 24 ns  
 $V_{CC} = 6.0$  V - - - - - 20 ns

**STANDARDIZED  
MILITARY DRAWING**  
DEFENSE ELECTRONICS SUPPLY CENTER  
DAYTON, OHIO 45444

SIZE  
**A**

5962-86062

REVISION LEVEL

B

SHEET

3

DESC FORM 193A  
SEP 87

\* U. S. GOVERNMENT PRINTING OFFICE: 1968-548-904

## 2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

### SPECIFICATION

#### MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

### STANDARD

#### MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

## 3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.2 Truth table. The truth table shall be as specified on figure 2.

3.2.3 Logic diagram. The logic diagram shall be as specified on figure 3.

3.2.4 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.

3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	<b>SIZE</b> <b>A</b>		5962-86062
		<b>REVISION LEVEL</b> B	<b>SHEET</b> 4

DESC FORM 193A  
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1986-548-904

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C < T <sub>C</sub> < +125°C unless otherwise specified 1/		Group A subgroups	Limits		Unit
					Min	Max	
High level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> (min) or V <sub>IL</sub> (max)  I <sub>O</sub>   ≤ 20 μA	V <sub>CC</sub> = 2.0 V	1, 2, 3	1.9		V
			V <sub>CC</sub> = 4.5 V		4.4		
			V <sub>CC</sub> = 6.0 V		5.9		
		V <sub>IN</sub> = V <sub>IH</sub> (min) or V <sub>IL</sub> (max)  I <sub>O</sub>   ≤ 6.0 mA	V <sub>CC</sub> = 4.5 V		3.7		
			V <sub>CC</sub> = 6.0 V		5.2		
Low level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> (min) or V <sub>IL</sub> (max)  I <sub>O</sub>   ≤ 20 μA	V <sub>CC</sub> = 2.0 V	1, 2, 3		0.1	
			V <sub>CC</sub> = 4.5 V			0.1	
			V <sub>CC</sub> = 6.0 V			0.1	
		V <sub>IN</sub> = V <sub>IH</sub> (min) or V <sub>IL</sub> (max)  I <sub>O</sub>   ≤ 6.0 mA	V <sub>CC</sub> = 4.5 V			0.4	
			V <sub>CC</sub> = 6.0 V			0.4	
High level input voltage 2/	V <sub>IH</sub>		V <sub>CC</sub> = 2.0 V	1, 2, 3	1.5		
			V <sub>CC</sub> = 4.5 V		3.15		
			V <sub>CC</sub> = 6.0 V		4.2		

See footnotes at end of table.

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>		5962-86062
		REVISION LEVEL <b>B</b>	SHEET <b>5</b>

DESC FORM 193A  
SEP 87

\* U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C < T <sub>C</sub> < +125°C unless otherwise specified <u>1/</u>	Group A subgroups	Limits		Unit
				Min	Max	
Low level input voltage <u>2/</u>	V <sub>IL</sub>		V <sub>CC</sub> = 2.0 V V <sub>CC</sub> = 4.5 V V <sub>CC</sub> = 6.0 V	1, 2, 3	0.3	V
					0.9	
					1.2	
Input capacitance	C <sub>IN</sub>	V <sub>IN</sub> = 0 V, T <sub>C</sub> = +25°C see 4.3.1c	4		10	pF
Quiescent current	I <sub>CC</sub>	V <sub>CC</sub> = 6.0 V V <sub>IN</sub> = V <sub>CC</sub> or GND	1, 2, 3		160	μA
Input leakage current	I <sub>IN</sub>	V <sub>CC</sub> = 6.0 V V <sub>IN</sub> = V <sub>CC</sub> or GND	1, 2, 3		±1	
Three-state output leakage current	I <sub>OZ</sub>	V <sub>O</sub> = V <sub>CC</sub> or GND V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	1, 2, 3		±10	μA
Output capacitance	C <sub>OUT</sub>	See 4.3.1c	4		20	pF
Functional tests		See 4.3.1d	7			
Propagation delay time, data to Q output (see fig. 4) <u>3/</u>	t <sub>PHL1</sub> t <sub>PLH1</sub>	T <sub>C</sub> = +25°C C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 2.0 V V <sub>CC</sub> = 4.5 V V <sub>CC</sub> = 6.0 V	9	175	ns
					35	
					30	
		T <sub>C</sub> = -55°C, +125°C C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 2.0 V V <sub>CC</sub> = 4.5 V V <sub>CC</sub> = 6.0 V	10, 11	265	
					53	
					45	

See footnotes at end of table.

**STANDARDIZED  
MILITARY DRAWING**DEFENSE ELECTRONICS SUPPLY CENTER  
DAYTON, OHIO 45444**SIZE  
A**

5962-86062

**REVISION LEVEL**

B

**SHEET**

6

DESC FORM 193A  
SEP 87

\* U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C < T <sub>C</sub> < +125°C unless otherwise specified 1/		Group A subgroups	Limits		Unit
					Min	Max	
Propagation delay time, latch enable to any output (see fig. 4) 3/	t <sub>PHL2</sub>	T <sub>C</sub> = +25°C	V <sub>CC</sub> = 2.0 V	9		175	ns
	t <sub>PLH2</sub>	C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 4.5 V			35	
			V <sub>CC</sub> = 6.0 V			30	
		T <sub>C</sub> = -55°C, +125°C C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 2.0 V	10, 11		265	
			V <sub>CC</sub> = 4.5 V			53	
			V <sub>CC</sub> = 6.0 V			45	
Propagation delay time, output enable to any output (see fig. 4) 3/	t <sub>PZH</sub>	T <sub>C</sub> = +25°C	V <sub>CC</sub> = 2.0 V	9		175	ns
	t <sub>PZL</sub>	C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 4.5 V			35	
			V <sub>CC</sub> = 6.0 V			30	
		T <sub>C</sub> = -55°C, +125°C C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 2.0 V	10, 11		265	
			V <sub>CC</sub> = 4.5 V			53	
			V <sub>CC</sub> = 6.0 V			45	

See footnotes at end of table.

**STANDARDIZED  
MILITARY DRAWING**

 DEFENSE ELECTRONICS SUPPLY CENTER  
DAYTON, OHIO 45444

 SIZE  
A

5962-86062

REVISION LEVEL

B

SHEET

7

 DESC FORM 193A  
SEP 87

\* U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

TABLE 1. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C < T <sub>C</sub> < +125°C unless otherwise specified 1/		Group A subgroups	Limits		Unit
					Min	Max	
Propagation delay time, output disable to any output (see fig. 4) 3/	t <sub>pHZ</sub>	T <sub>C</sub> = +25°C	V <sub>CC</sub> = 2.0 V	9		150	ns
	t <sub>pLZ</sub>	C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 4.5 V			30	
			V <sub>CC</sub> = 6.0 V			26	
		T <sub>C</sub> = -55°C, +125°C C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 2.0 V	10, 11		225	
			V <sub>CC</sub> = 4.5 V			45	
			V <sub>CC</sub> = 6.0 V			38	
Transition time, output rise and fall (see fig. 4) 4/	t <sub>THL</sub>	T <sub>C</sub> = +25°C	V <sub>CC</sub> = 2.0 V	9		60	ns
	t <sub>TLH</sub>	C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 4.5 V			12	
			V <sub>CC</sub> = 6.0 V			10	
		T <sub>C</sub> = -55°C, +125°C C <sub>L</sub> = 50 pF ±10%	V <sub>CC</sub> = 2.0 V	10, 11		90	
			V <sub>CC</sub> = 4.5 V			18	
			V <sub>CC</sub> = 6.0 V			15	

1/ For a power supply of 5 V ±10%, the worst case output voltages (V<sub>OH</sub> and V<sub>OL</sub>) occur for V<sub>CC</sub> at 4.5 V. Thus, the 4.5 V values should be used when designing with this supply. Worst cases V<sub>IH</sub> and V<sub>IL</sub> occur at V<sub>CC</sub> = 5.5 V and 4.5 V, respectively. (The V<sub>IH</sub> value at 5.5 V is 3.85 V.) The worst case leakage currents (I<sub>IN</sub>, I<sub>CC</sub>, and I<sub>OZ</sub>) occur for CMOS at the higher voltage, so the 6.0 V values should be used. Power dissipation capacitance (C<sub>PD</sub>), typically 50 pF, determines the no load dynamic power consumption, P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup> f + I<sub>CC</sub> V<sub>CC</sub>, and the no load dynamic current consumption, I<sub>S</sub> = C<sub>PD</sub> V<sub>CC</sub> f + I<sub>CC</sub>.

2/ V<sub>IL</sub> and V<sub>IH</sub> tests not required. Apply as forcing function for V<sub>OH</sub> and V<sub>OL</sub>.

3/ AC testing at V<sub>CC</sub> = 2.0 V and V<sub>CC</sub> = 6.0 V shall be guaranteed if not tested to the specified parameters.

4/ Transition times, if not tested, shall be guaranteed to the specified parameters.

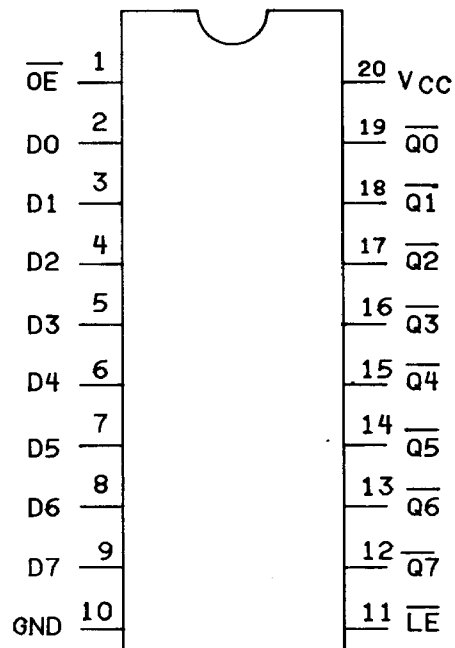
<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	<b>SIZE</b> <b>A</b>		5962-86062
		<b>REVISION LEVEL</b> B	<b>SHEET</b> 8

DESC FORM 193A  
SEP 87

★ U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904



Cases R and S



Case 2

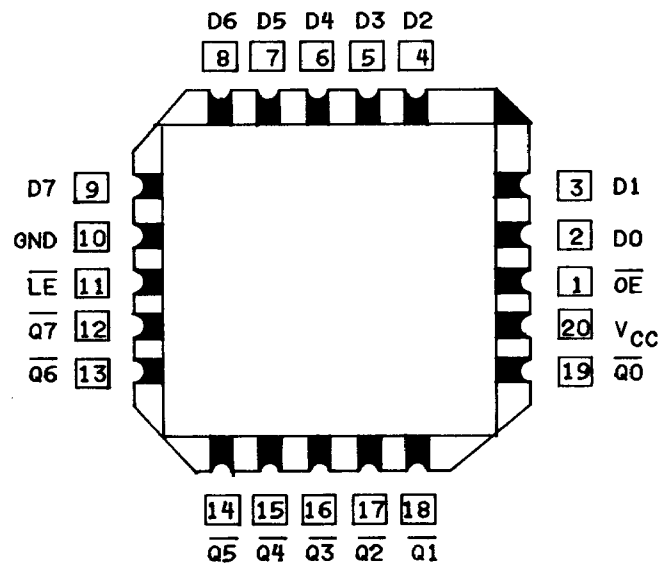


FIGURE 1. Terminal connections (top view).

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>	5962-86062	
		REVISION LEVEL B	SHEET 9

DESC FORM 193A  
SEP 87

★ U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

Output Enable	Latch Enable	Data	$\overline{Q}$ Output
L	H	H	L
L	H	L	H
L	L	1	H
L	L	h	L
H	X	X	Z

NOTE

L = Low voltage level

H = High voltage level

1 = Low voltage level one set-up time  
prior to the high to low latch enable transition

h = High voltage level one set-up time  
prior to the high to low latch enable transition

X = Don't care

Z = High impedance state

FIGURE 2. Truth table.

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>	5962-86062	
		REVISION LEVEL B	SHEET 10

DESC FORM 193A  
SEP 87

★ U. S. GOVERNMENT PRINTING OFFICE: 1986-549-904

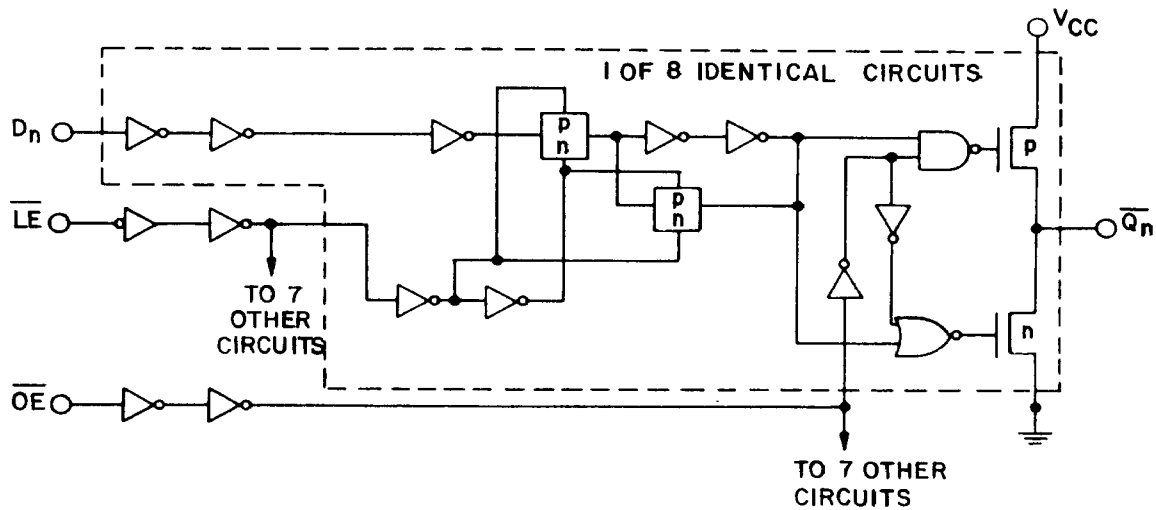


FIGURE 3. Logic diagram

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>		5962-86062
		REVISION LEVEL B	SHEET 11

DESC FORM 193A  
SEP 87

U. S. GOVERNMENT PRINTING OFFICE: 1968-549-904

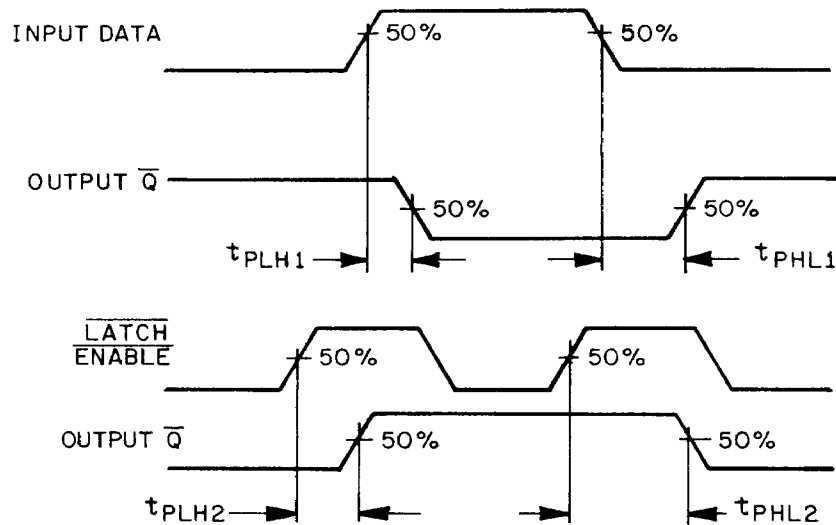
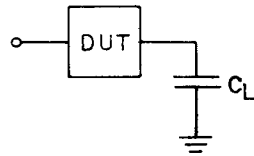
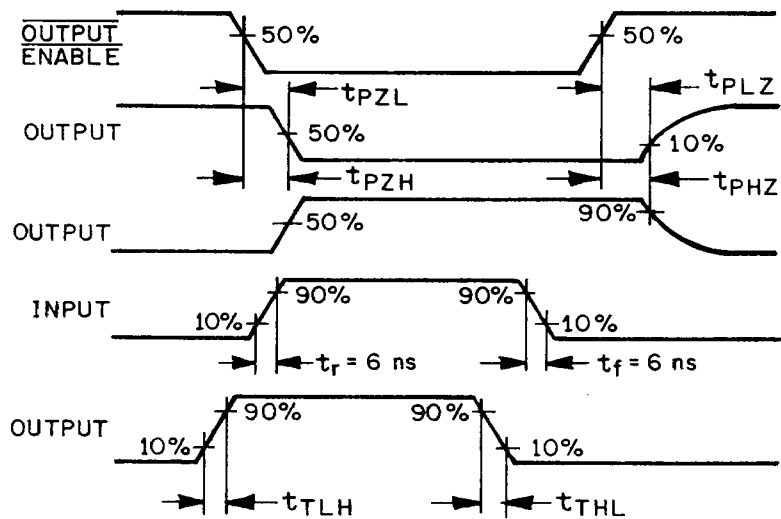
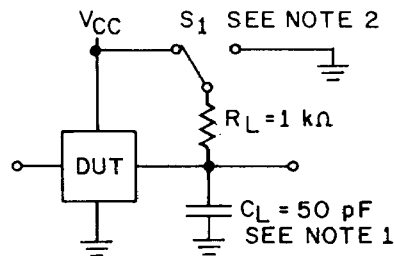


FIGURE 4. Test circuits and switching waveforms.

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>		5962-86062
		REVISION LEVEL B	SHEET 12

DESC FORM 193A  
SEP 87

★ U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904



NOTES:

1.  $C_L$  includes load and test jig.
2.  $S_1 = V_{CC}$  for  $t_{PZL}$  and  $t_{PLZ}$ .  
 $S_1 = GND$  for  $t_{PZH}$  and  $t_{PHZ}$ .

FIGURE 4. Test circuits and switching waveforms - Continued.

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>		5962-86062
		REVISION LEVEL <b>B</b>	SHEET <b>13</b>

DESC FORM 193A  
SEP 87

★ U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.8 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

#### 4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).

(2)  $T_A = +125^{\circ}\text{C}$ , minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

##### 4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 5, 6, and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.

c. Subgroup 4 ( $C_{IN}$  and  $C_{OUT}$  measurements) shall be measured only for the initial test and after process or design changes which may affect capacitance. Test all applicable pins on 5 devices with 0 failures.

d. Subgroup 7 tests sufficiently to verify the truth table.

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>		5962-86062
		REVISION LEVEL B	SHEET 14

DESC FORM 193A  
SEP 87

☆ U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

#### 4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883:
  - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
  - (2)  $T_A = +125^{\circ}\text{C}$ , minimum.
  - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*,2,9
Group A test requirements (method 5005)	1,2,3,4,7,9, 10**,11**
Groups C and D end-point electrical parameters (method 5005)	1,2,3

\* PDA applies to subgroup 1.

\*\* Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

#### 5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

#### 6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.

6.2 Replaceability. Replaceability is determined as follows:

- a. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- b. When a QPL source is established, the part numbered device specified in this drawing will be replaced by the microcircuit identified as part number M38510/65405B--.

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>		5962-86062
		REVISION LEVEL <b>B</b>	SHEET <b>15</b>

DESC FORM 193A  
SEP 87

\* U. S. GOVERNMENT PRINTING OFFICE: 1986-549-904

6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

6.4 Approved sources of supply. Approved sources of supply are listed herein. Additional sources will be added as they become available. The vendors listed herein have agreed to this drawing and a certificate of compliance (see 3.5 herein) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor similar part number <u>1/</u>	Replacement military specification part number
5962-8606201RX	27014 18714 01295	MM54HC563J/883 CD54HC563F/3A SNJ54HC563J	M38510/65405BRX
5962-8606201SX	01295	SNJ54HC563W	M38510/65405BSX
5962-86062012X	01295 27014	SNJ54HC563FK MM54HC563E/883	M38510/65405B2X

1/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number

Vendor name and address

27014

National Semiconductor  
2900 Semiconductor Drive  
P. O. Box 58090  
Santa Clara, CA 95052-8090

18714

RCA Corporation  
Solid State Division  
Route 202  
Somerville, NJ 08876

01295

Texas Instruments, Incorporated  
P. O. Box 6448  
Midland, TX 79701

<b>STANDARDIZED MILITARY DRAWING</b> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE <b>A</b>	5962-86062	
		REVISION LEVEL B	SHEET 16

DESC FORM 193A  
SEP 87

★ U. S. GOVERNMENT PRINTING OFFICE: 1988-549-904

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